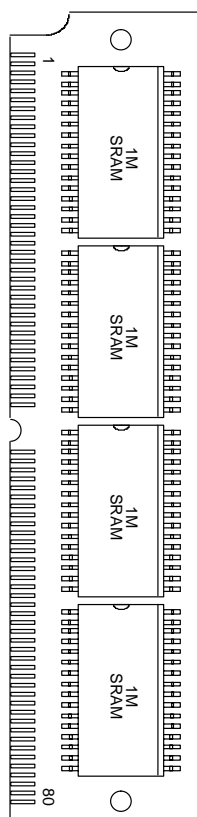


FEATURES

- Organized as a high density 512K x 16 bit Stik™
- Fast access time of 85 ns
- Unlimited write cycles
- Employs popular JEDEC standard 80-position SIMM connector
- Full $\pm 10\%$ operating range
- Read cycle time equals write cycle time
- Ultra-low standby current $< 10 \mu\text{A}$
- Suitable for battery-backed applications

PIN ASSIGNMENT



80-pin SIP Stik

DESCRIPTION

The DS2229 is a 8,388,608-bit low-power fully static Random Access Memory organized as a 524,888 word by 16 bits using CMOS technology. The device employs the popular JEDEC standard 80-pin SIMM connection scheme with no additional circuitry required. The device operates from a single power supply with a voltage input of 4.5 to 5.5 volts. The Chip Enable inputs ($\overline{\text{CE0}}$, $\overline{\text{CE1}}$, $\overline{\text{CE2}}$, $\overline{\text{CE3}}$) are used for device selection and can be

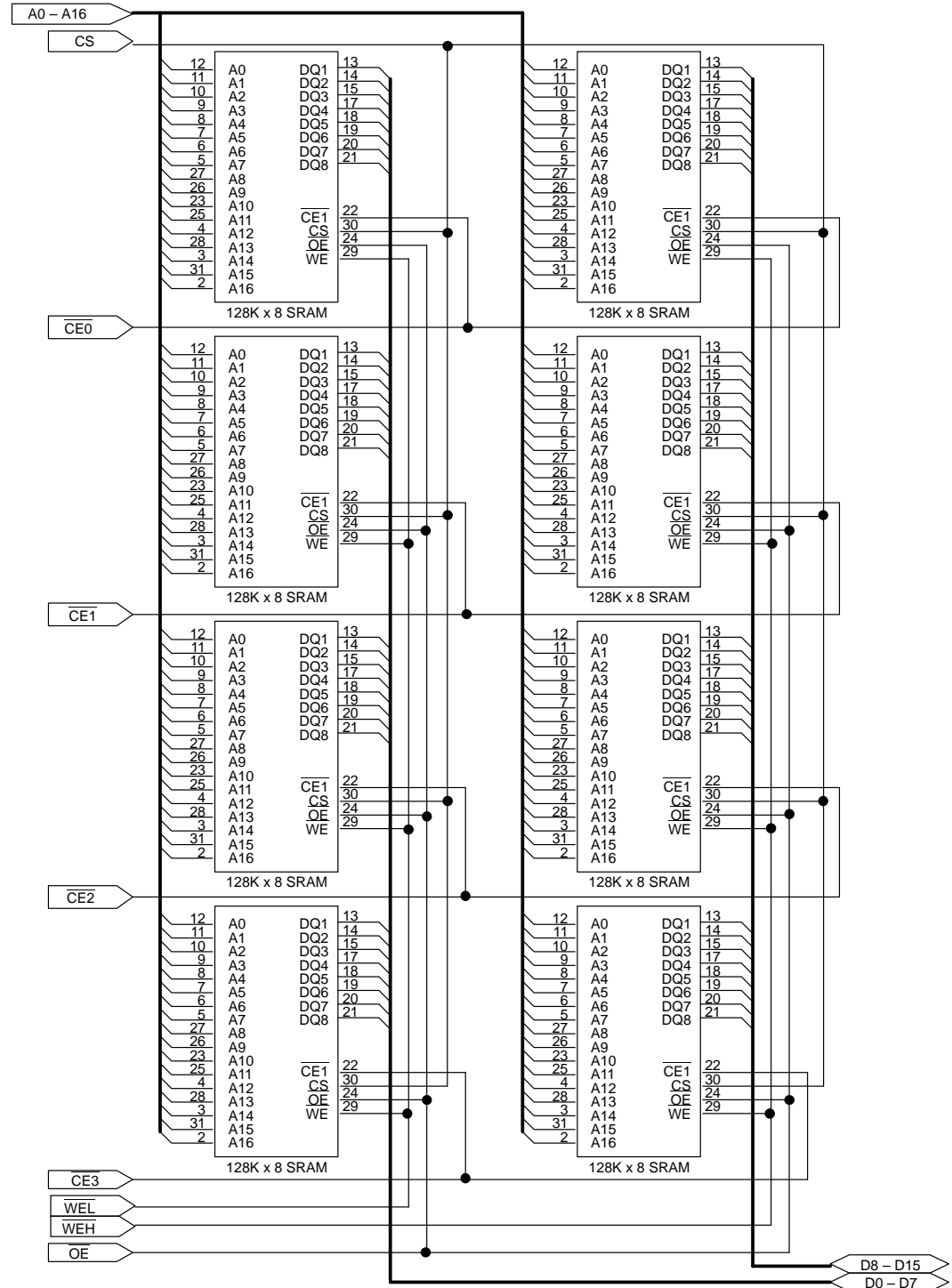
used in order to achieve the minimum standby current mode which facilitates battery backup. The device provides a fast access time of 85 ns. The DS2229 maintains TTL levels over input voltage range 4.5V to 5.5V. The DS2229 is JEDEC pin compatible (see Figure 1) with flash EEPROM memory SIMM boards of similar density.

PIN DESCRIPTION Figure 1

PIN #	PIN NAME	PIN #	PIN NAME	PIN #	PIN NAME
1	GND	32	NC	63	DQ ₇
2	V _{CC}	33	NC	64	DQ ₆
3	NC	34	NC	65	DQ ₅
4	OE	35	NC	66	DQ ₄
5	WEH	36	A ₁₆	67	DQ ₃
6	WEL	37	A ₁₅	68	DQ ₂
7	NC	38	A ₁₄	69	DQ ₁
8	CS	39	A ₁₃	70	DQ ₀
9	NC	40	A ₁₂	71	NC
10	NC	41	A ₁₁	72	V _{CC}
11	NC	42	A ₁₀	73	NC
12	NC	43	A ₉	74	GND
13	NC	44	A ₈	75	NC
14	NC	45	A ₇	76	GND
15	NC	46	A ₆	77	GND
16	NC	47	A ₅	78	NC
17	NC	48	A ₄	79	NC
18	NC	49	A ₃	80	GND
19	NC	50	A ₂		
20	NC	51	A ₁		
21	CE3	52	A ₀		
22	CE2	53	GND		
23	CE1	54	GND		
24	CE0	55	DQ ₁₅		
25	GND	56	DQ ₁₄		
26	NC	57	DQ ₁₃		
27	NC	58	DQ ₁₂		
28	NC	59	DQ ₁₁		
29	NC	60	DQ ₁₀		
30	NC	61	DQ ₉		
31	NC	62	DQ ₈		

PIN NAME	DESCRIPTION
A ₀ – A ₁₆	Address Input
WEL	Write Enable Input Low
WEH	Write Enable Input High
OE	Output Enable Input
NC	No Connect
CE0 – CE3	Chip Enable Input
CS	Chip Select
DQ ₀ – DQ ₁₅	Data Input/Output
V _{CC}	+5 Volts
GND	Ground

DS2229 STATIC RAM MODULE FUNCTION DIAGRAM Figure 2



ABSOLUTE MAXIMUM RATINGS*

Power Supply Voltage	-0.3V to +7.0V
Input, Input/Output Voltage	-0.3 to $V_{CC} + 0.3V$
Operating Temperature	0°C to 70°C
Storage Temperature	-55°C to +125°C

* This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

OPERATION MODE

MODE	$\overline{CE0} - \overline{CE3}$	CS	\overline{OE}	\overline{WE}	A0 – A16	DQ – DQ15	POWER
READ	L	H	L	H	STABLE	DATA OUT	I_{CC0}
WRITE	L	H	X	L	STABLE	DATA IN	I_{CC0}
DESELECT	L	H	H	H	X	HIGH-Z	I_{CC0}
STANDBY	H	X	X	X	X	HIGH-Z	I_{CCS1}, I_{CCS2}
STANDBY	X	L	X	X	X	HIGH-Z	I_{CCS1}, I_{CCS2}

CAPACITANCE $(t_A = 25^\circ\text{C})$

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Capacitance	C_{IN}			64	pF	
Input/Output Capacitance	$C_{I/O}$			80	pF	

RECOMMENDED DC OPERATING CONDITIONS $(t_A = 0^\circ\text{C to } 70^\circ\text{C})$

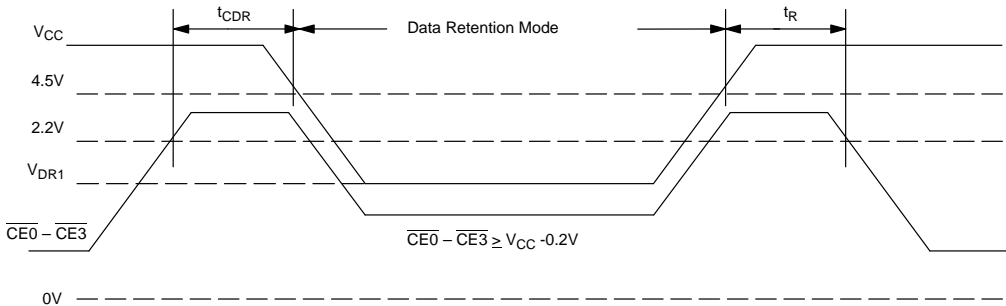
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Power Supply Voltage	V_{CC}	4.5	5.0	5.5	V	
Input High Voltage	V_{IH}	2.0		$V_{CC} + 0.3$	V	
Input Low Voltage	V_{IL}	-0.3		0.8	V	

DC CHARACTERISTICS $(t_A = 0^\circ\text{C to } 70^\circ\text{C}; V_{CC} = 5V \pm 10\%)$

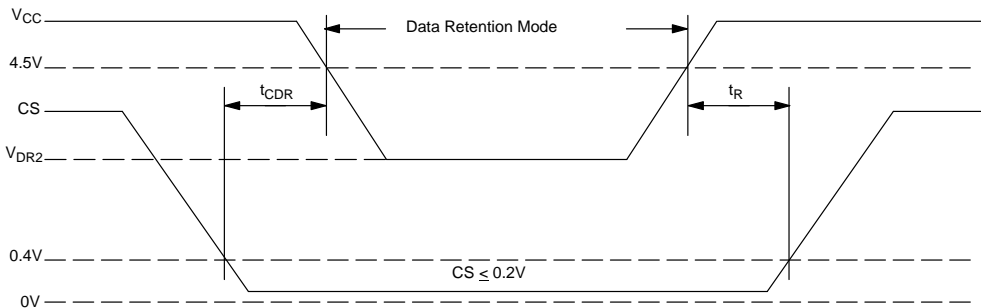
PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS	NOTES
Input Leakage Current	I_{IL}	$0V \leq V_{IN} \leq V_{CC}$		8	μA	
I/O Leakage Current	I_{LO}	$\overline{CE0} - \overline{CE3} = V_{IH}, 0V \leq V_{I/O} \leq V_{CC}$		8	μA	
Output High Current	I_{OH}	$V_{OH} = 2.4V$	-1.0		mA	
Output Low Current	I_{OL}	$V_{OL} = 0.4V$	2.1		mA	
Standby Current	I_{CCS1}	$\overline{CE0} - \overline{CE3} = 2.0V, t_A = 25^\circ\text{C}$		8	mA	
Standby Current	I_{CCS2}	$\overline{CE0} - \overline{CE3} \geq V_{CC} - 0.3V, t_A = 25^\circ\text{C}$		10	μA	
Operating Current	I_{CC0}	$\overline{CE0} - \overline{CE3} = 0.8V; \text{Cycle} = 100 \text{ ns}$ $t_A = 25^\circ\text{C}$		100	mA	9

LOW V_{CC} DATA RETENTION CHARACTERISTICS(t_A = 0°C to 70°C)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	TEST CONDITION
V _{CC} for Data Retention	V _{DR}	2.0	—	—	V	$\overline{CE0} - \overline{CE3} \geq V_{CC} - 0.2V$, $CS \geq V_{CC} - 0.2V$ or $0V \leq CS \leq 0.2V$ $V_{IN} \geq 0V$
Data Retention Current	I _{CCDR}	—	1	8	μA	$V_{CC} = 3.0V$, $V_{IN} \geq 0V$ $\overline{CE0} - \overline{CE3} \geq V_{CC} - 0.2V$, $CS \geq V_{CC} - 0.2V$ or $0V \leq CS \leq 0.2V$ t _A =25°C
Chip Deselect to Data Retention Time	t _{CDR}	0	—	—	ns	See Retention Waveform
Operation Recovery Time	t _R	5	—	—	ms	

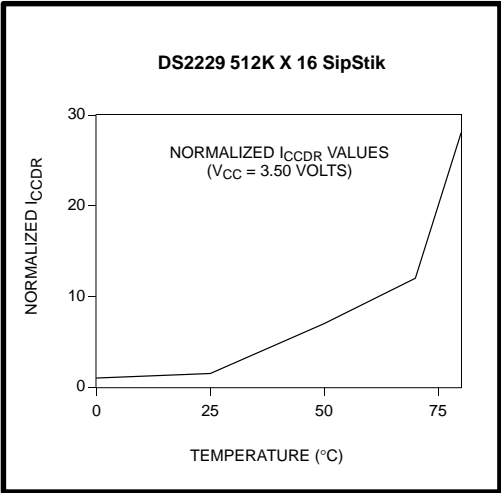
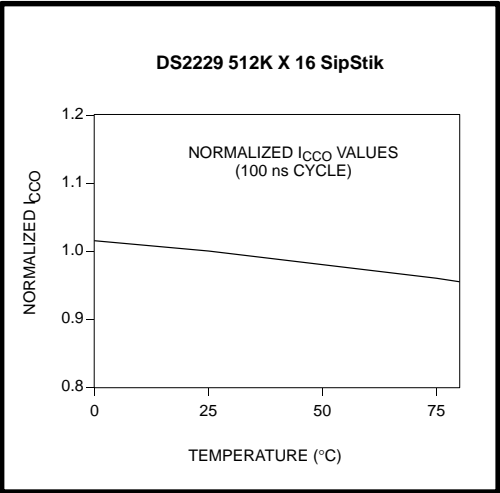
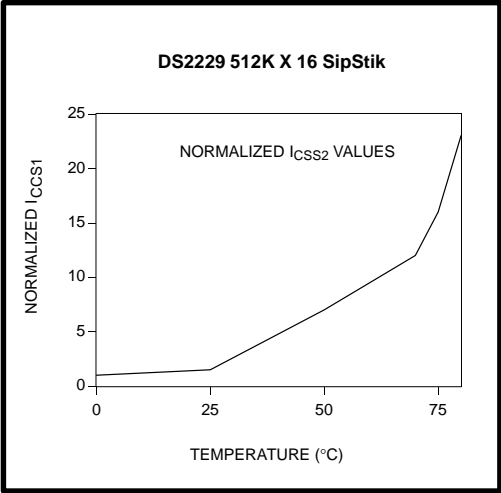
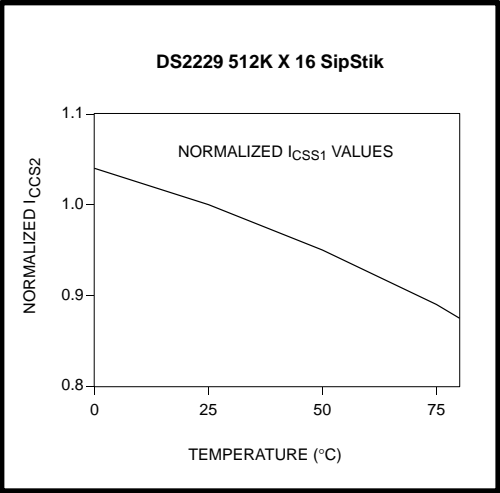
LOW V_{CC} DATA RETENTION TIMING WAVEFORM (1) ($\overline{CE0} - \overline{CE3}$ Controlled) Figure 3

SEE NOTE 5

LOW V_{CC} DATA RETENTION TIMING WAVEFORM (2) (CS Controlled) Figure 4

SEE NOTE 5

PRODUCT CHARACTERISTICS



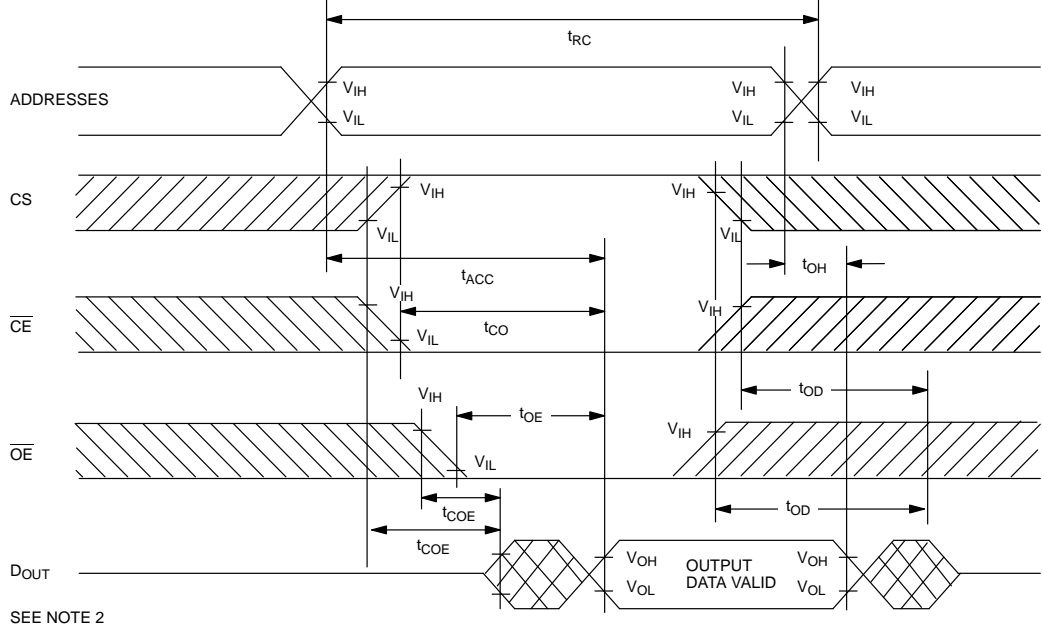
AC ELECTRICAL CHARACTERISTICS READ CYCLE(0°C to 70°C; $V_{CC} = 5V \pm 10\%$)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Read Cycle Time	t_{RC}	85			ns	
Access Time	t_{ACC}			85	ns	
\overline{OE} to Output Valid	t_{OE}			45	ns	
$\overline{CE0} - \overline{CE3}$ to Output Valid	t_{CO}			85	ns	
\overline{OE} or $\overline{CE0} - \overline{CE3}$ to Output In Low-Z	t_{COE}	10			ns	8
Output High-Z from Deselection	t_{OD}	0		30	ns	8
Output Hold from Address Change	t_{OH}	10			ns	

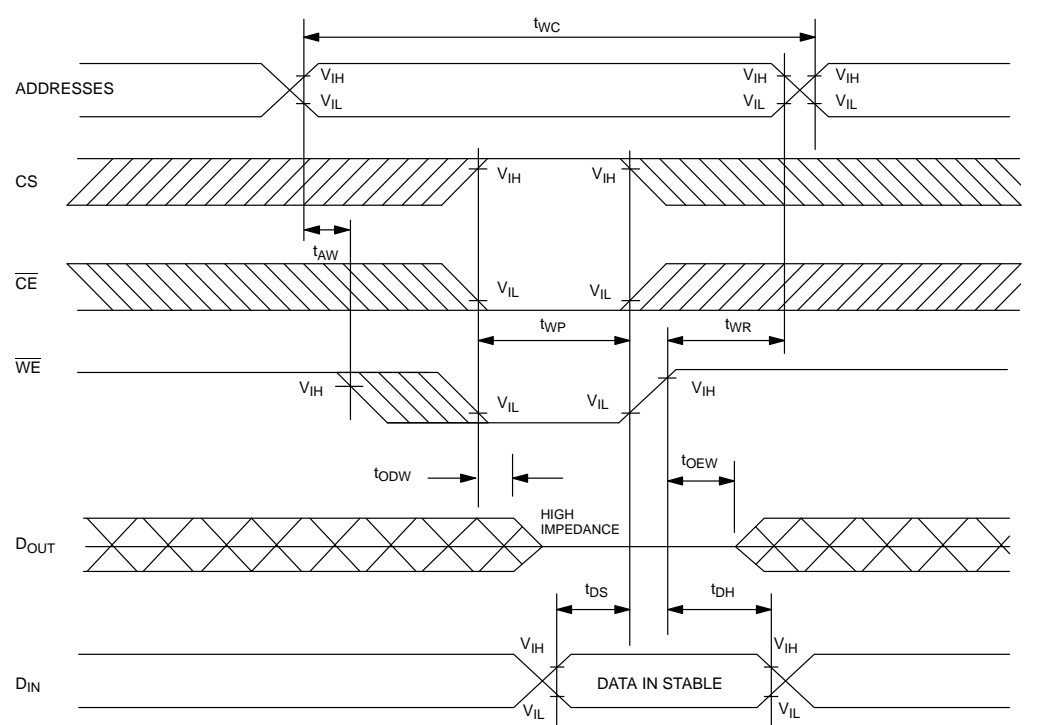
AC ELECTRICAL CHARACTERISTICS WRITE CYCLE(0°C to 70°C; $V_{CC} = 5V \pm 10\%$)

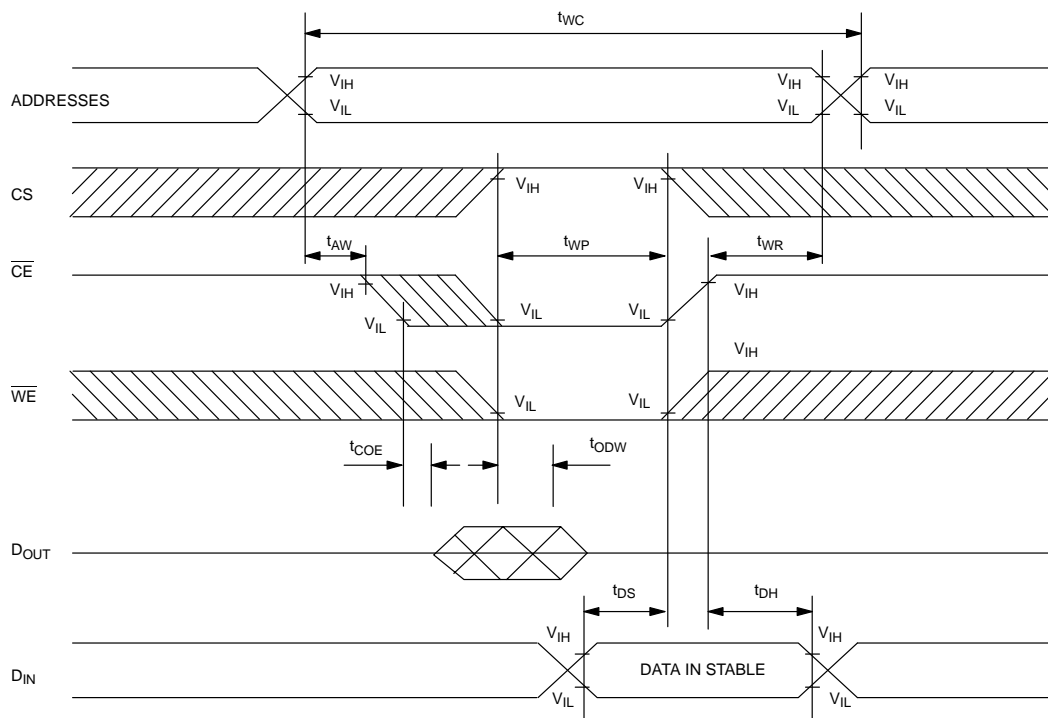
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Write Cycle Time	t_{WC}	85			ns	
Write Pulse Width	t_{WP}	65			ns	1
Address Setup Time	t_{AW}	0			ns	
Write Recovery Time	t_{WR}	10			ns	4
Output High-Z from \overline{WE}	t_{ODW}	0		30	ns	8
Output Active from \overline{WE}	t_{OEW}	5			ns	8
Data Setup Time	t_{DS}	35			ns	3
Data Hold Time from \overline{WE}	t_{DH}	0			ns	3

READ CYCLE Figure 5



WRITE CYCLE1 Figure 6



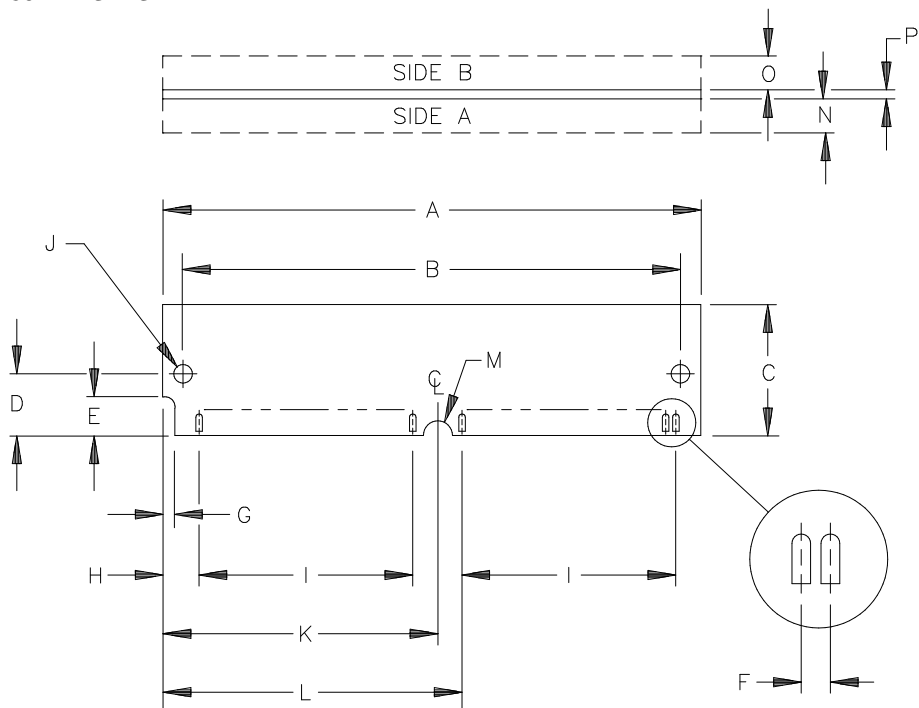
WRITE CYCLE 2 Figure 7

SEE NOTES 1, 3, 4, 6, 7, AND 9

NOTES:

1. A write occurs during the overlap of a low $\overline{CE0} - \overline{CE3}$, a high CS , and a low \overline{WE} . A write begins at the latest transition among $\overline{CE0} - \overline{CE3}$ going low, CS going high, and \overline{WE} going low. A write ends at the earliest transition among $\overline{CE0} - \overline{CE3}$ going high, CS going low and \overline{WE} going high. t_{WP} is measured from the beginning of write to the end of write.
2. \overline{WE} is high for a read cycle.
3. t_{DS} ends and t_{DH} begins at the earliest transaction among $\overline{CE0} - \overline{CE3}$ going high.
4. t_{WR} is measured from the earliest of $\overline{CE0} - \overline{CE3}$ or \overline{WE} going high or CS going low to the end of write cycle.
5. CS controls address buffer, \overline{WE} buffer, $\overline{CE0} - \overline{CE3}$ buffer, \overline{OE} buffer and D_{IN} buffer. If CS controls data retention mode, V_{IN} levels (address, \overline{WE} , \overline{OE} , $\overline{CE0} - \overline{CE3}$, I/O) can be in the high impedance state. If $\overline{CE0} - \overline{CE3}$ controls data retention mode, CS must be $CS \geq V_{CC} - 0.2V$ or $0V \leq CS \leq 0.2V$. The other input levels (address, \overline{WE} , \overline{OE} , I/O) can be in the high impedance state.
6. If $\overline{CE0} - \overline{CE3}$ goes low simultaneously with \overline{WE} going low or after \overline{WE} going low, the outputs remain in a high impedance state.
7. If $\overline{CE0} - \overline{CE3}$ is low and CS is high during this period, I/O pins are in the output state. Therefore, the input signals of the opposite phase to the outputs must not be applied to them.
8. This parameter is sampled and not 100% tested.
9. Only one \overline{CE} active during any read or write cycle.

DS2229 80-PIN SIP STIK



PKG	80-PIN	
DIM	MIN	MAX
A	4.645	4.655
B	4.379	4.389
C	0.729	0.739
D	0.395	0.405
E	0.245	0.255
F	0.050 BSC	
G	0.075	0.085
H	0.245	0.255
I	1.950 BSC	
J	0.120	0.130
K	2.320	2.330
L	2.445	2.455
M	0.057	0.067
N		0.130
O		0.130
P		0.054